

JF K\$) \*      GE G`      Silicon PNP transistor in a SOT-23 Plastic Package.

$V_{CE(sat)}$   
High current gain, Low collector-emitter saturation voltage.

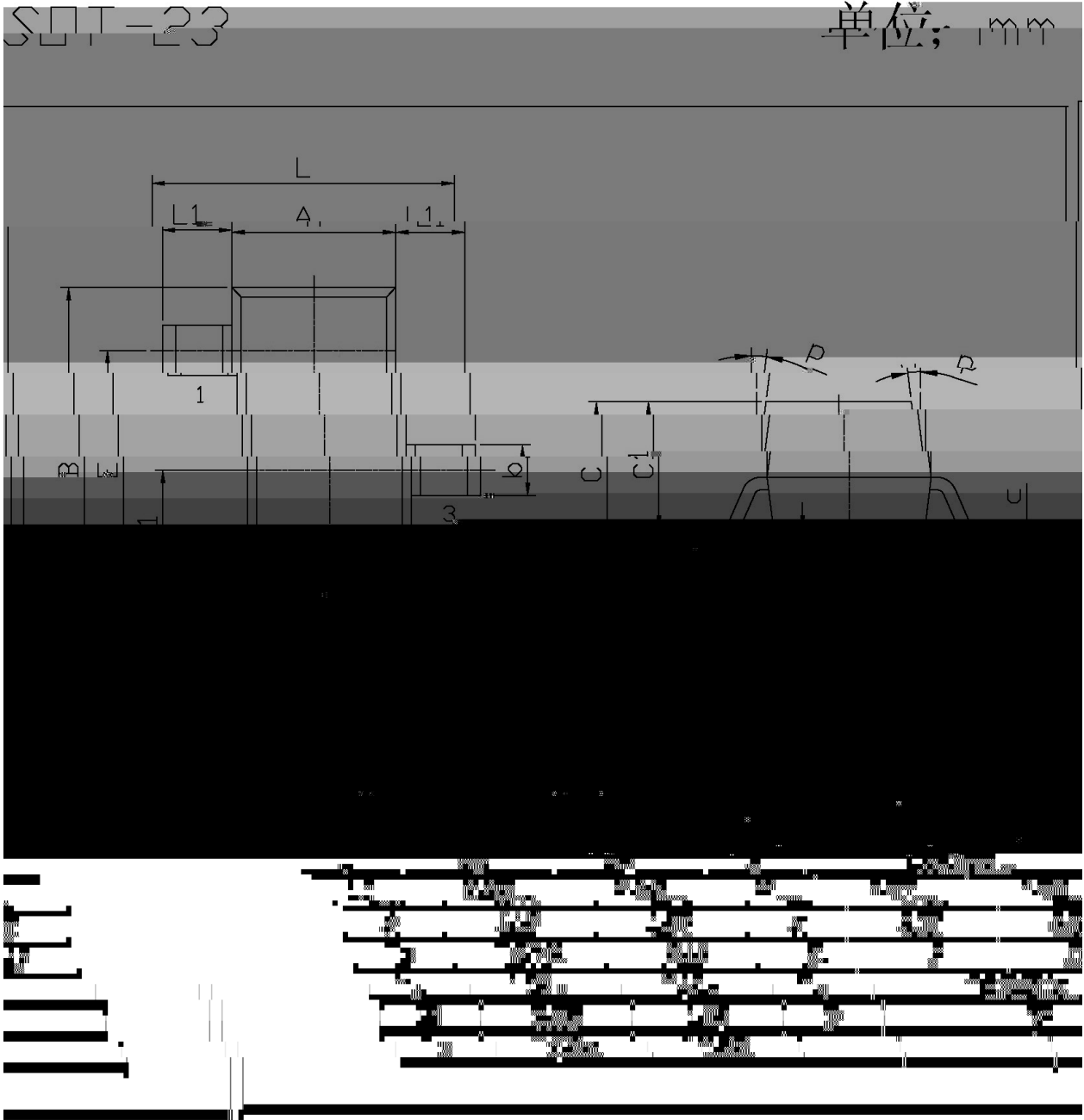
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Parameter	Symbol	Rating	Unit
Collector to Base Voltage	$V_{CBO}$	-50	V
Collector to Emitter Voltage	$V_{CEO}$	-45	V
Emitter to Base Voltage	$V_{EBO}$	-5.0	V
Collector Current - Continuous	$I_C$	-100	mA
Collector Power Dissipation	$P_C$	350	mW
Junction Temperature	$T_j$	150	
Storage Temperature Range	$T_{stg}$	-55 150	

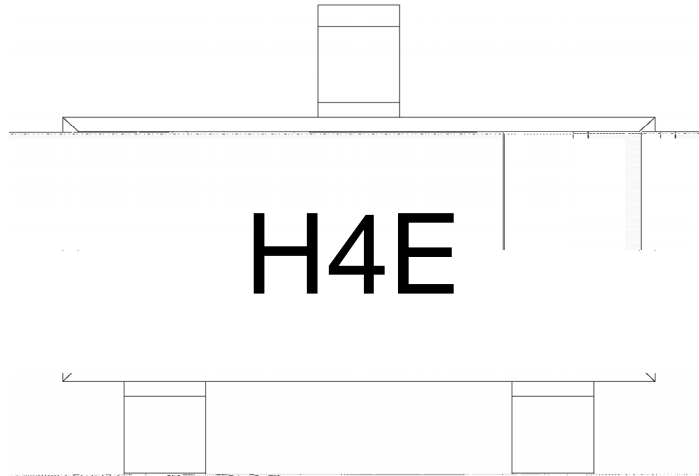
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Emitter Breakdown Voltage	$V_{CEO}$	$I_C = -10mA$ $I_B = 0$	-45			V
Collector to Base Breakdown Voltage	$V_{CBO}$	$I_C$ I E O				



/ Package Dimensions



**/ Marking Instructions**



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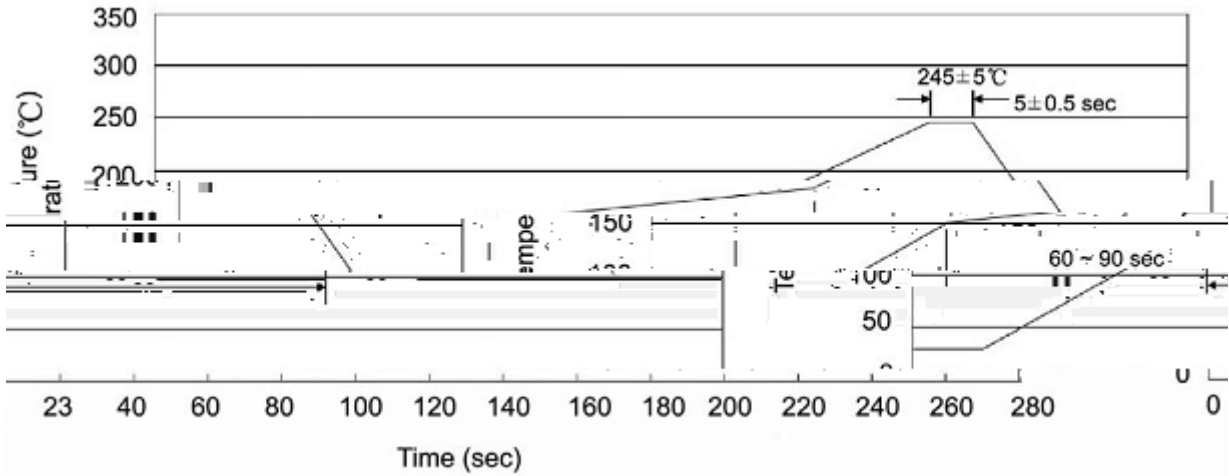
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**Note:**

H:        Company Code.

4E:      Product Type Code

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- |   |        |           |   |
|---|--------|-----------|---|
| 1 | 25 150 | 60 90sec; | 1.Preheating:25~150 , Time:60~90sec.    |
| 2 | 245±5  | 5±0.5sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | 2~10   | /sec.     | 3. Cooling Speed: 2~10 /sec.            |

/ Resistance to Soldering Heat Test Conditions

260±5                      10±1 sec.                      Temp.:260±5                      Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm <sup>3</sup> )		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices